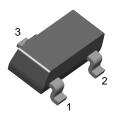
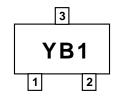


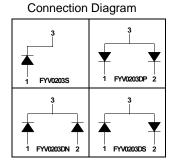
FYV0203S/DN/DP/DS



SOT-23



MarkingFYV0203S = YB1 FYV0203DP = YB3
FYV0203DN = YB2 FYV0203DS = YB4



Schottky Diode

Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{RRM}	Maximum Repetitive Reverse Voltage	30	V
Average Rectified Forward Current		0.2	А
I _{FSM}	Non-repetitive Peak Surge Current Pulse Width = 1.0s	0.6	А
T _{STG}	Storage Temperature Range	-65 to +150	°C
T _J	Operating Junction Temperature	150	°C

Thermal Characteristics

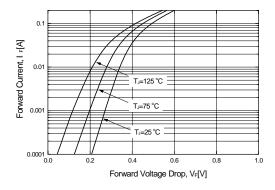
Symbol	Parameter	Value	Units
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	430	°C/W

Electrical Characteristics T_A=25°C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Units
V _F *	Forward Voltage Drop					mV
	$I_F = 0.1 \text{mA}$		-	210	240	
	$I_F = 1mA$		-	270	320	
	I _F = 10mA		-	340	400	
	I _F = 30mA		-	390	500	
	I _F = 100mA		-	485	800	
	I _F = 200mA		-	600	1000	
I _R *	Reverse Current					uA
	@ Rated V _R	T _A = 25 °C	-	0.2	2	
		T _A = 125 °C	-	130	-	
Ст	Total Capacitance	•				pF
•	$V_{R} = 1V$, $f = 1.0 \text{ MHz}$		-	-	10	
t _{rr}	Reverse Recovery Time					ns
	$I_{\rm F} = I_{\rm R} = 10 \rm mA, \ I_{\rm RR} = 1 mA, \ R_{\rm L} = 100 \Omega$		-	-	5	

^{*} Pulse Test: Pulse Width=300μs, Duty Cycle=2%

Typical Characteristics



1000 T;=125 °C 100 T;=75 °C 100 T;=75 °C 100 100 T;=75 °C 100 100 Reverse Voltage, V_R[V]

Figure 1. Typical Forward Voltage Characteristics

Figure 2. Typical Reverse Current vs. Reverse Voltage

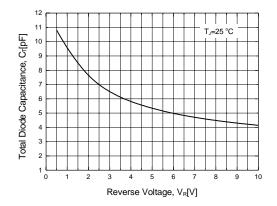
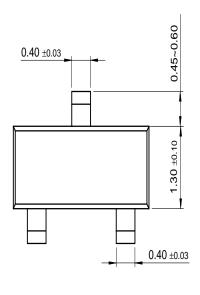


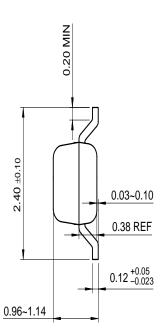
Figure 3. Total Diode Capacitance

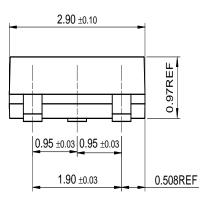
©2001 Fairchild Semiconductor Corporation Rev. A, September 2001

Package Dimensions

SOT-23







Dimensions in Millimeters

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACEx™	FAST [®]	OPTOLOGIC™	SMART START™	VCX^{TM}
Bottomless™	FASTr™	OPTOPLANAR™	STAR*POWER™	
CoolFET™	FRFET™	PACMAN™	Stealth™	
$CROSSVOLT^{TM}$	GlobalOptoisolator™	POP™	SuperSOT™-3	
DenseTrench™	GTO™	Power247™	SuperSOT™-6	
DOME™	HiSeC™	PowerTrench [®]	SuperSOT™-8	
EcoSPARK™	ISOPLANAR™	QFET™	SyncFET™	
E ² CMOS™	LittleFET™	QS TM	TruTranslation™	
EnSigna™	MicroFET™	QT Optoelectronics™	TinyLogic™	
FACT™	MicroPak™	Quiet Series™	UHC™ _	
FACT Quiet Series™	MICROWIRE™	SLIENT SWITCHER®	UltraFET [®]	

STAR*POWER is used under license

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR INTERNATIONAL.

As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.
- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

©2001 Fairchild Semiconductor Corporation Rev. H4

